

MOS FIELD EFFECT TRANSISTOR μ PA1810

P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA1810 is a switching device which can be driven directly by a 2.5 V power source.

The μ PA1810 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- Can be driven by a 2.5 V power source
- · Low on-state resistance

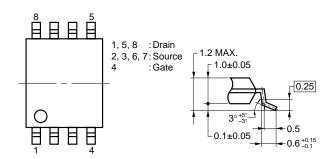
RDS(on)1 = 55 m Ω MAX. (VGS = -4.5 V, ID = -2.0 A) RDS(on)2 = 60 m Ω MAX. (VGS = -4.0 V, ID = -2.0 A)

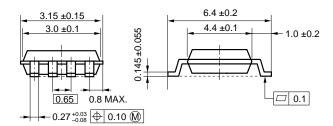
RDS(on)3 = 100 m Ω MAX. (VGS = -2.5 V, ID = -2.0 A)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1810GR-9JG	Power TSSOP8

PACKAGE DRAWING (Unit: mm)

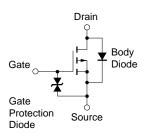




ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C)

Drain to Source Voltage	VDSS	-12	V
Gate to Source Voltage	Vgss	-10/+5	V
Drain Current (DC)	ID(DC)	±4.0	Α
Drain Current (pulse) Note1	D(pulse)	±16	Α
Total Power Dissipation Note2	PT	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

EQUIVALENT CIRCUIT



- **Notes 1.** PW \leq 10 μ s, Duty Cycle \leq 1 %
 - 2. Mounted on ceramic substrate of 5000 mm² x 1.1 mm

Remark

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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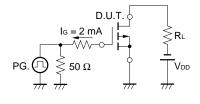
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V _{DS} = -12 V, V _{GS} = 0 V			-10	μΑ
Gate Leakage Current	Igss	Vgs = ±10 V, Vps = 0 V			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$	-0.5	-0.8	-1.5	V
Forward Transfer Admittance	yfs	$V_{DS} = -10 \text{ V}, I_{D} = -2.0 \text{ A}$	2.5	8.5		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = -4.5 V, I_{D} = -2.0 A$		41	55	mΩ
	RDS(on)2	$V_{GS} = -4.0 \text{ V}, I_{D} = -2.0 \text{ A}$		43	60	mΩ
	RDS(on)3	$V_{GS} = -2.5 \text{V}, I_{D} = -2.0 \text{A}$		71	100	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		1100		pF
Output Capacitance	Coss	V _G s = 0 V		750		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		240		pF
Turn-on Delay Time	td(on)	V _{DD} = -10 V		40		ns
Rise Time	t r	ID = -2.0 A		100		ns
Turn-off Delay Time	t _{d(off)}	V _{GS(on)} = -4.0 V		90		ns
Fall Time	tf	$R_G = 5 \Omega$		70		ns
Total Gate Charge	Q _G	V _{DD} = -10 V		35		nC
Gate to Source Charge	Qss	ID = -4.0 A		5		nC
Gate to Drain Charge	Q _{GD}	V _{GS} = -4.0 V		16		nC
Diode Forward Voltage	V _{F(S-D)}	IF = 4.0 A, VGS = 0 V		0.75		V
Reverse Recovery Time	trr	IF = 4.0 A, VGS = 0 V		50		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μS		35		nC

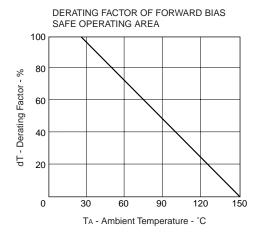
TEST CIRCUIT 1 SWITCHING TIME

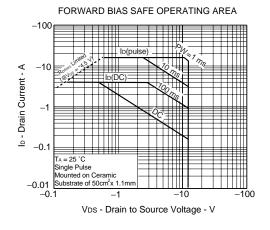
PG. $\bigcap_{R_G} R_G = 10 \ \Omega$ V_{DD} V_{GS} 0 10 % $V_{GS}(on)$ $V_{GS}(on)$

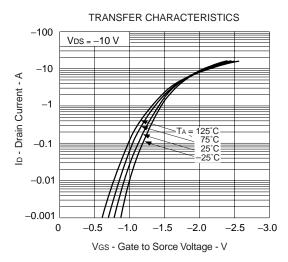
TEST CIRCUIT 2 GATE CHARGE

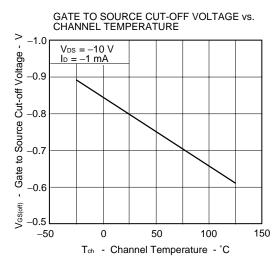


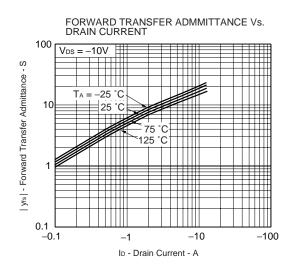
TYPICAL CHARACTERISTICS (TA = 25 °C)

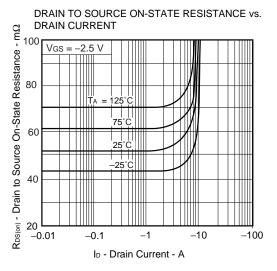


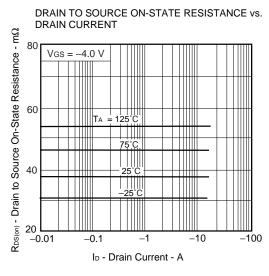


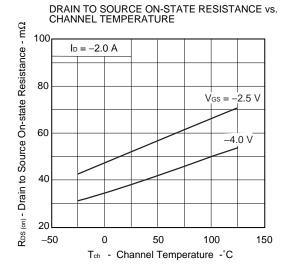


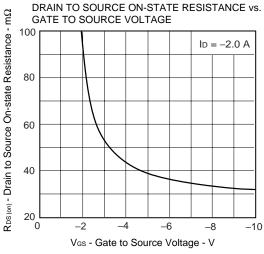


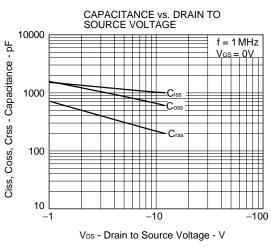


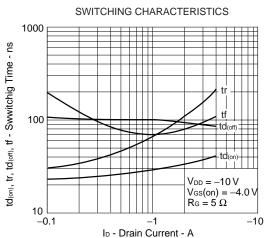


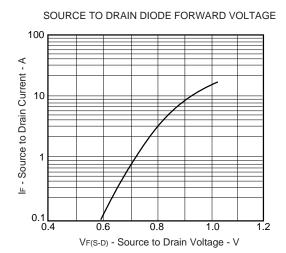




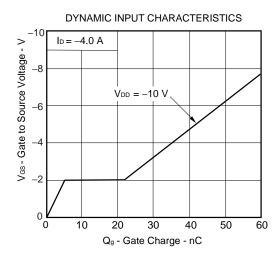




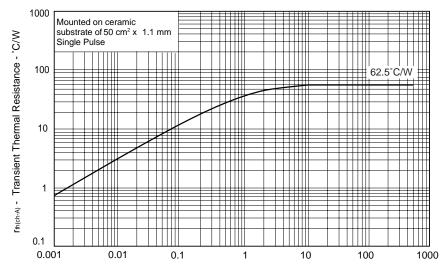




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TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



PW - Pulse Width - s

[MEMO]

NEC μ PA1810

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